

PRODUCT DATA SHEET

TACFlux® 102HFA

Introduction

TACFlux® 102HFA is a no-clean, halogen-free flux formulated for both hand soldering and rework. **TACFlux® 102HFA** is compatible with typical Pb-free (SAC) alloys for PCB assembly applications. **TACFlux® 102HFA** provides clear post-reflow residue for no-clean applications and excellent ICT compatibility.

Properties

Industry Standard Test Results	
Test	Result
Flux Classification	ROLO
Halogen-Free per IEC 61249-2-21, Test Method EN14582	<900ppm Cl <900ppm Br <1,500ppm Total
Typical Viscosity*	9kcps
Typical Tack	130g
Typical Acid Value	160mg KOH/G
SIR (J-STD-004B)	Pass
ECM (J-STD-004B)	Pass
Flux-Induced Corrosion (Cu Mirror)	Pass
Corrosion	Pass

*Brookfield Cone & Plate (CP51, 5rpm, 5 minutes, 25°C).

Additional Test Results	
Test	Result
Appearance	Clear
Maximum Reflow Temperature	260°C
Reflow Atmosphere	Air or nitrogen
Shelf Life	1 year @ 0–30°C
Storage Condition	Stored @ 0–30°C (tip down for syringe or cartridge)

All information is for reference only.

Not to be used as incoming product specifications.

This product data sheet is provided for general information only. It is not intended, and shall not be construed, to warrant or guarantee the performance of the products described which are sold subject exclusively to written warranties and limitations thereon included in product packaging and invoices. All Indium Corporation's products and solutions are designed to be commercially available unless specifically stated otherwise.

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

From One Engineer To Another®

Contact our engineers: askus@indium.com

Learn more: www.indium.com

ASIA +65 6268 8678 • CHINA +86 (0) 512 628 34900 • EUROPE +44 (0) 1908 580400 • USA +1 315 853 4900

Packaging

TACFlux® 102HFA is available in 10 and 30cc syringes or 100g jars; however, other packaging can be provided to meet specific requirements.

Cleaning

TACFlux® 102HFA is designed for no-clean applications. If necessary, the flux can be removed by using a commercially available flux cleaner.

Reflow

Peak reflow temperature should be <260°C in an air or nitrogen atmosphere.

Storage

TACFlux® 102HFA syringes and cartridges should be stored tip down at 0–30°C. If refrigerated, **TACFlux® 102HFA** should be thawed for 4 hours at room temperature before using.

Technical Support

Indium Corporation's internationally experienced engineers provide in-depth technical assistance to our customers. Thoroughly knowledgeable in all facets of Materials Science as it applies to the electronics and semiconductor sectors, Technical Support Engineers provide expert advice in solder properties, alloy compatibility and selection of solder preforms, wire, ribbon, and paste. Indium Corporation's Technical Support Engineers provide rapid response to all technical inquiries.

Safety Data Sheets

Please refer to the SDS document within the product shipment, or contact our local team to receive a copy.



Form No. 100057 R0

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